life.augmented

TO-220FP

ultra narrow leads

D(2)

S(3)

Figure 1: Internal schematic diagram

G(1) O

STFU23N80K5

N-channel 800 V, 0.23 Ω typ., 16 A MDmesh[™] K5 Power MOSFET in a TO-220FP ultra narrow leads package

Datasheet - production data



Order code	VDS	RDS(on) max.	ID	Ртот
STFU23N80K5	800 V	0.28 Ω	16 A	35 W

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh[™] K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

NG1D2S3Z

Order code	Marking	Package	Packing
STFU23N80K5	23N80K5	TO-220FP ultra narrow leads	Tube

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This is information on a product in full production.

www.st.com

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1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±30	V
Ip	Drain current (continuous) at T _{case} = 25 °C	16	А
ID	Drain current (continuous) at T _{case} = 100 °C		A
I _{DM} ⁽¹⁾	Drain current (pulsed)	64	А
Ртот	Total dissipation at T _{case} = 25 °C	35	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	4.5	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	v/ns
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t= 1 s, T_{c} = 25 °C)		V
T _{stg}	Storage temperature range -55 to 150		°C
Tj	Operating junction temperature range		C

Notes:

 $\ensuremath{^{(1)}}\ensuremath{\mathsf{Pulse}}$ width is limited by safe operating area.

 $^{(2)}I_{SD} \leq$ 16 A, di/dt=100 A/µs, V_{DS} peak < V(BR)DSS, V_{DD} = 80% V(BR)DSS $^{(3)}V_{DS} \leq$ 640 V

Table 3: Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case	3.6	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	50	

Table 4: Avalanche characteristics

Symbol	Parameter		Unit
I _{AR} ⁽¹⁾	Avalanche current, repetitive or not repetitive		А
Eas ⁽²⁾	Single pulse avalanche energy		mJ

Notes:

 $^{(1)}\mbox{Pulse}$ width limited by $T_{jmax}.$

 $^{(2)}Starting T_{j}$ = 25 °C, ID = IAR, VDD = 50 V.



2 Electrical characteristics

(T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	V_{GS} = 0 V, I_D = 1 mA	800			V
	Zara gata valtaga drain	$V_{GS} = 0 V, V_{DS} = 800 V$			1	
IDSS	Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 800 V,$ $T_{case} = 125 \ ^{\circ}C^{(1)}$			50	μA
I _{GSS}	Gate-body leakage current	V_{DS} = 0 V, V_{GS} = ±20 V			±10	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \ \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8 \text{ A}$		0.23	0.28	Ω

Notes:

⁽¹⁾Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1000	-	
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz, V _{GS} = 0 V	I	65	-	pF
Crss	Reverse transfer capacitance	VG3 - V V	I	1.5	-	
C _{O(tr)} ⁽¹⁾	Equivalent output capacitance	V_{DS} = 0 to 640 V, V_{GS} = 0 V	-	165	-	۶L
C _{O(er)} ⁽²⁾	Equivalent output capacitance	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$ V	I	59	-	pF
R_{G}	Intrinsic gate resistance	$f = 1 MHz, I_D = 0 A$	-	4.7	-	Ω
Qg	Total gate charge	$V_{DD} = 640 \text{ V}, \text{ I}_{D} = 16 \text{ A},$	I	33	-	
Q _{gs}	Gate-source charge	V _{GS} = 0 to 10 V (see <i>Figure 14: "Test circuit</i>	-	6	-	nC
Q_{gd}	Gate-drain charge	for gate charge behavior")	-	25	-	

Table 6: Dynamic

Notes:

 $^{(1)}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when VDs increases from 0 to 80% VDSS.

 $^{(2)}\mathsf{E}\mathsf{nergy}$ related is defined as a constant equivalent capacitance giving the same stored energy as Coss when Vps increases from 0 to 80% Vpss.



Electrical characteristics

	Table 7: Switching times							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit		
t _{d(on)}	Turn-on delay time	V _{DD} = 400 V, I _D = 8 A	-	14	-			
tr	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 13: "Test circuit for	-	9	-			
td(off)	Turn-off delay time	resistive load switching times"	-	48	-	ns		
tr	Fall time	and Figure 18: "Switching time waveform")	-	9	-			

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Isd	Source-drain current		-		16	А
Isdm ⁽¹⁾	Source-drain current (pulsed)		-		64	А
Vsd ⁽²⁾	Forward on voltage	V_{GS} = 0 V, I_{SD} = 16 A	-		1.5	V
trr	Reverse recovery time	I _{SD} = 16 A, di/dt = 100 A/µs,	-	410		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V (see Figure 15: "Test circuit for	-	7		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	34		А
t _{rr}	Reverse recovery time	I _{SD} = 16 A, di/dt = 100 A/µs,	-	650		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{\text{j}} = 150 ^{\circ}\text{C}$ (see Figure 15: "Test circuit for	-	10		μC
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	32		A

Notes:

⁽¹⁾ Pulse width is limited by safe operating area.

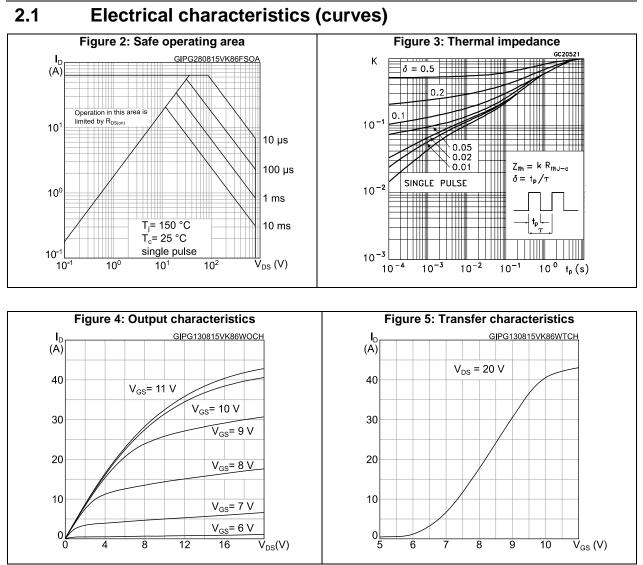
 $^{(2)}$ Pulse test: pulse duration = 300 $\mu s,$ duty cycle 1.5%.

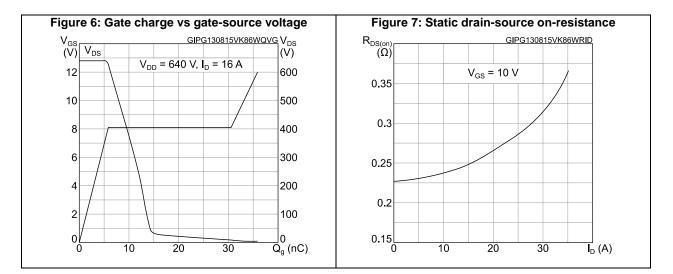
Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _(BR) GSO	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	±30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.







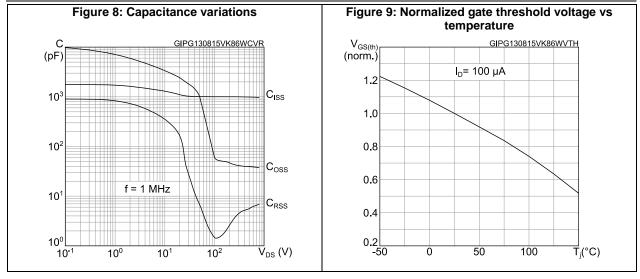
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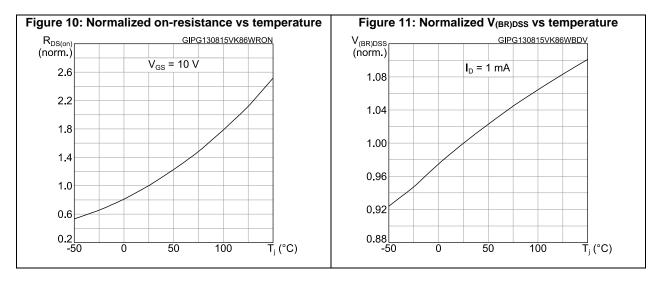


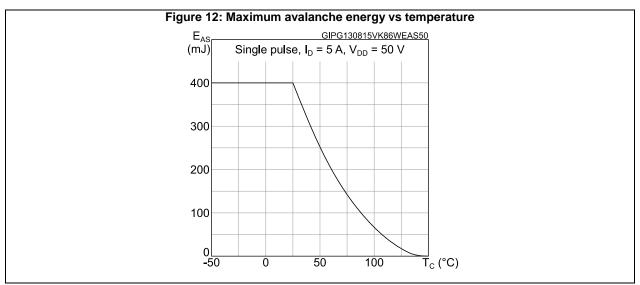
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Electrical characteristics

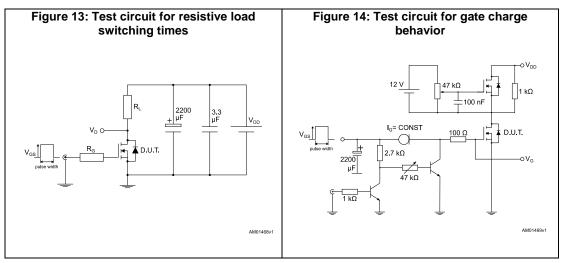


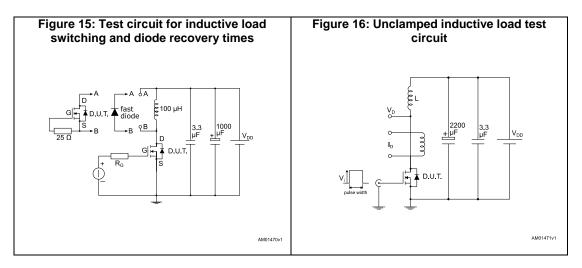


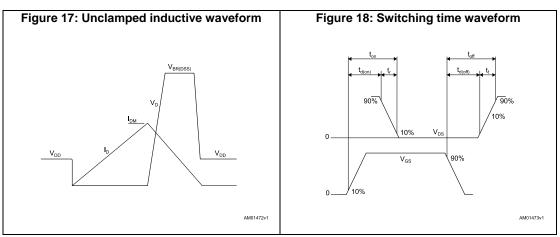


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3 Test circuits







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4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

4.1 TO-220FP ultra narrow leads package information

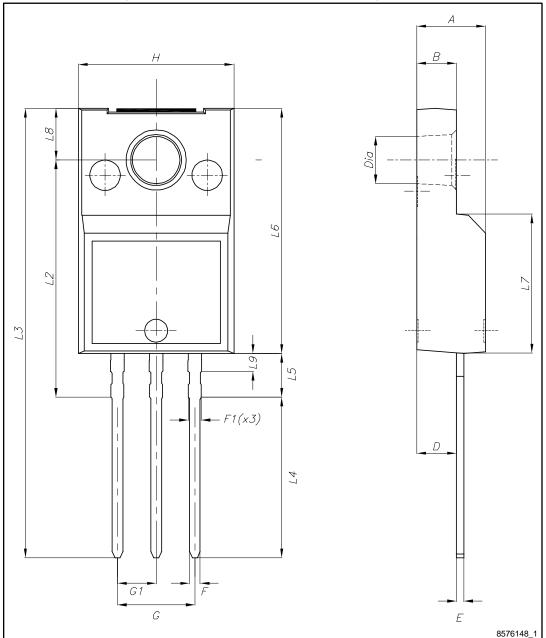


Figure 19: TO-220FP ultra narrow leads package outline



Package information

STFU23N80K5

nformation	ormation STFU23N80K5						
Та	ble 10: TO-220FP ultra na	rrow leads mechanical	data				
Dim		mm					
Dim.	Min.	Тур.	Max.				
А	4.40		4.60				
В	2.50		2.70				
D	2.50		2.75				
E	0.45		0.60				
F	0.65		0.75				
F1	-		0.90				
G	4.95		5.20				
G1	2.40	2.54	2.70				
Н	10.00		10.40				
L2	15.10		15.90				
L3	28.50		30.50				
L4	10.20		11.00				
L5	2.50		3.10				
L6	15.60		16.40				
L7	9.00		9.30				
L8	3.20		3.60				
L9	-		1.30				
Dia.	3.00		3.20				



5 Revision history

Date	Revision	Changes
21-Feb-2017	1	First release



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